

IN THE SPECIFICATION:

Kindly replace paragraph 1 on page 1 with the following new paragraph:

A1 This application is related to U.S. Patent Application Serial No. 10/029,570, entitled "Method and Apparatus for Shape Forming Endovascular Graft Material", by Chobotov, et al., U.S. Patent Application Serial No. 10/029,557, entitled "Method and Apparatus for Manufacturing an Endovascular Graft Section", by Chobotov et al., and U.S. Patent Application Serial No. 10/029,559, entitled "Advanced Endovascular Graft", by Chobotov et al. All of the above applications are commonly owned and were filed on even date herewith. All of the above applications are hereby incorporated by reference, each in their entirety.

Kindly delete the paragraph beginning on page 3, line 16 and continuing to page 4, line 5 and replace with the following new paragraph:

A2 An embodiment of the invention is directed to the formation of a joint between ^a connector member and a flexible material portion of an endovascular graft, or section thereof. A flap of the flexible material portion is fixed about at least a portion of the connector member such that tensile force imposed on the connector member is transferred into a shear component of force on the fixed portion of the flap. Such a configuration provides a high strength joint with a low profile or low cross sectional mass that will allow the graft to be compressed radially for flexible low profile percutaneous delivery to a body conduit of a patient. Such a joining method also provides for ease of manufacture of the graft. The connector member can be an annular connector member suitable for connection to an expandable member or stent. MC
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